



Parameters	Ratings	Units
Blocking Voltage	600	V _P
Load Current	150	mA
Max On-resistance	22	Ω

Features

- 5000V_{rms} Input/Output Isolation
- Small 6-Pin DIP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

Applications

- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment: Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

The PLA192 is a single-pole, normally open (1-Form-A) solid state relay that uses optically coupled relay technology to provide an enhanced 5000V_{rms} isolation barrier between the input and the output of the relay.

The efficient MOSFET switches use Clare's patented OptoMOS architecture while the optically coupled output is controlled by a highly efficient GaAIAs infrared LED.

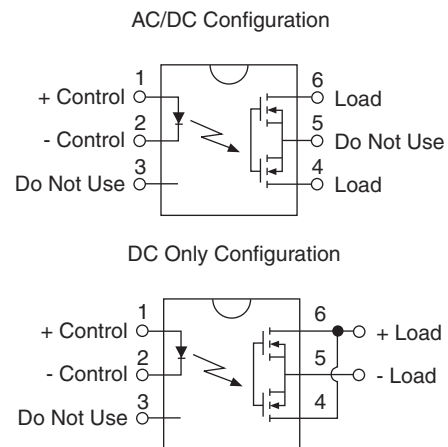
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

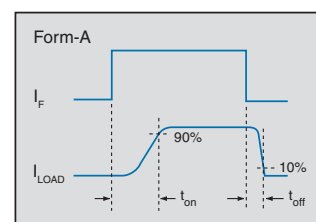
Ordering Information

Part #	Description
PLA192	6-Pin DIP (50/Tube)
PLA192S	6-Pin Surface Mount (50/Tube)
PLA192STR	6-Pin Surface Mount (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Min	Max	Units
Blocking Voltage	-	600	V _P
Reverse Input Voltage	-	5	V
Input Control Current	-	50	mA
Peak (10ms)	-	1	A
Input Power Dissipation ¹	-	150	mW
Total Package Dissipation ²	-	800	mW
Isolation Voltage, Input to Output	5000	-	V _{rms}
Operational Temperature	-40	+85	°C
Storage Temperature	-40	+125	°C

¹ Derate linearly 1.33 mW / °C

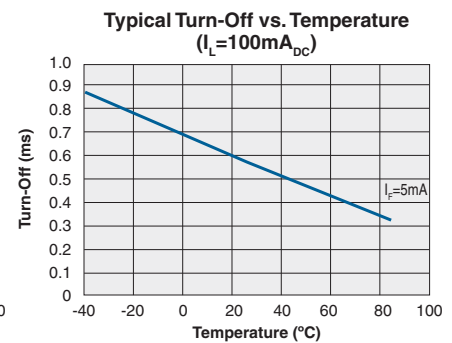
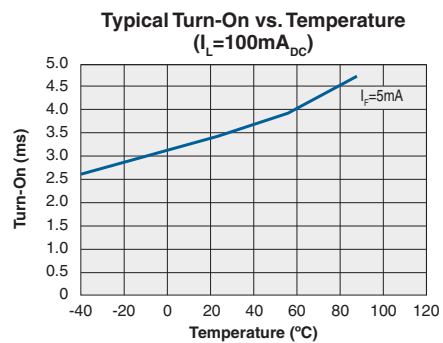
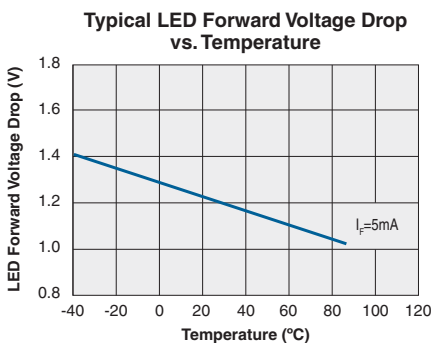
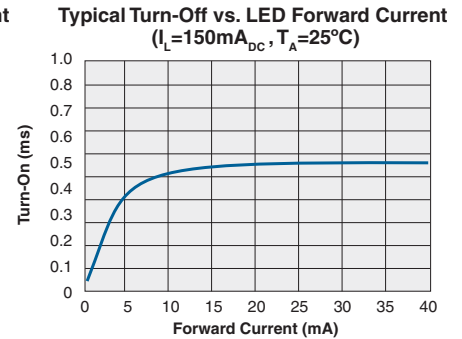
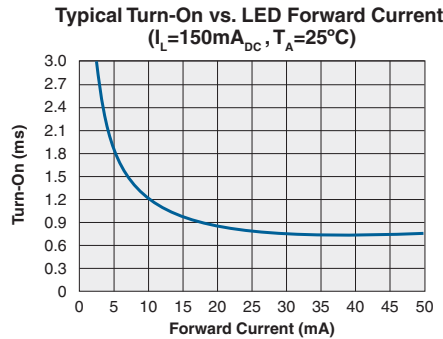
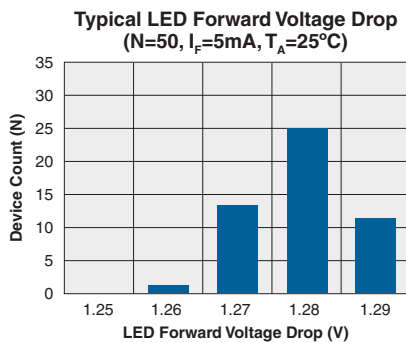
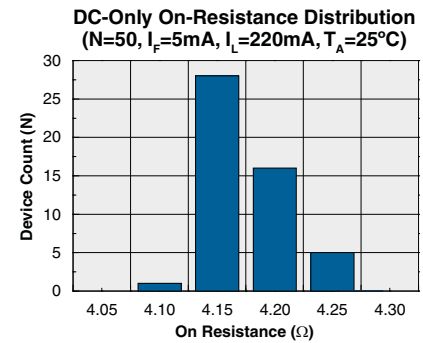
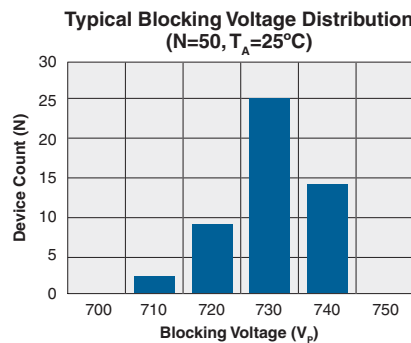
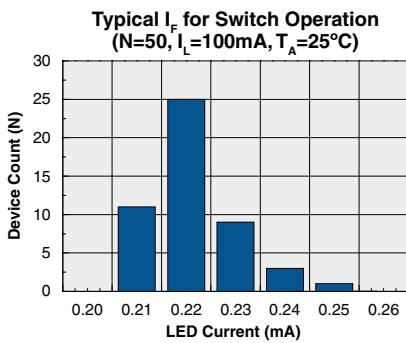
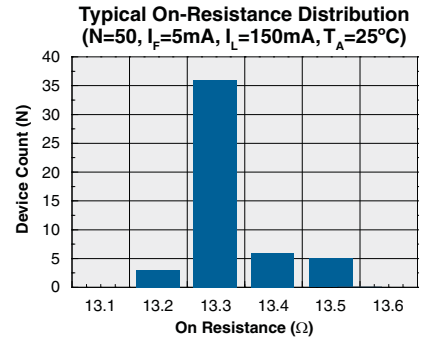
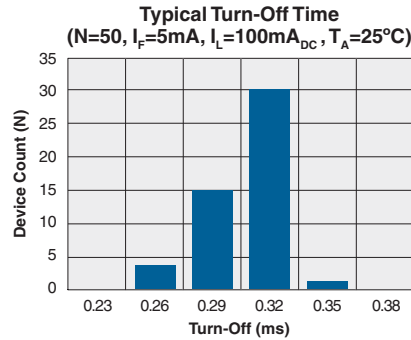
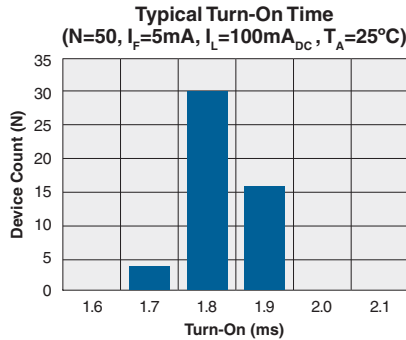
² Derate linearly 6.67 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous, AC/DC Configuration	-	I _L	-	-	150	mA
Continuous, DC Configuration	-		-	-	220	
Peak	t=10ms	I _{LPK}	-	-	400	
On-Resistance						
AC/DC Configuration	I _L =150mA	R _{ON}	-	13.3	22	Ω
DC Configuration	I _L =220mA		-	4.15	8	
Off-State Leakage Current	V _L =600V _P	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	t _{on}	-	-	5	ms
Turn-Off		t _{off}	-	-	5	
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	50	-	pF
Input Characteristics						
Input Control Current	I _L =100mA	I _F	-	0.22	5	mA
Input Dropout Current	-	I _F	0.2	0.21	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Input to Output Capacitance	-	C _{IO}	-	3	-	pF

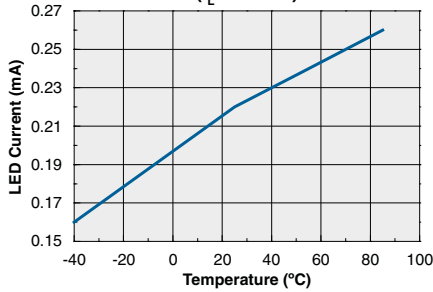
PERFORMANCE DATA*



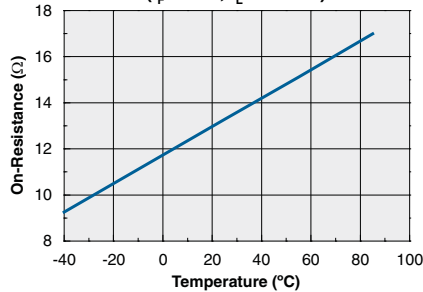
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

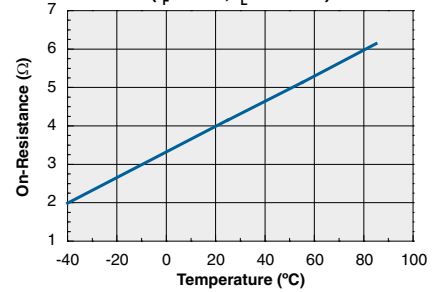
Typical I_F for Switch Operation vs. Temperature
($I_L=100mA$)



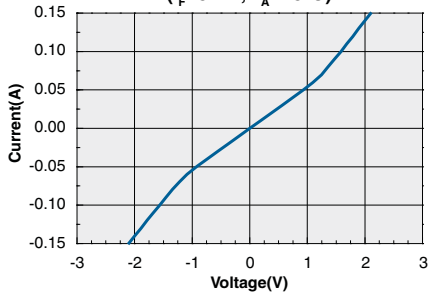
Typical On-Resistance vs. Temperature
($I_F=5mA, I_L=150mA$)



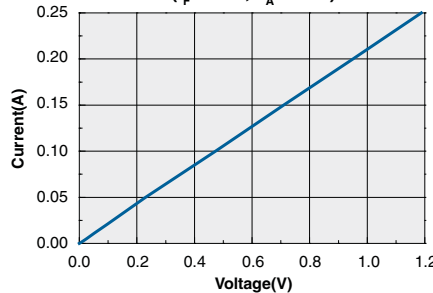
Typical DC-Only On-Resistance vs. Temperature
($I_F=5mA, I_L=220mA$)



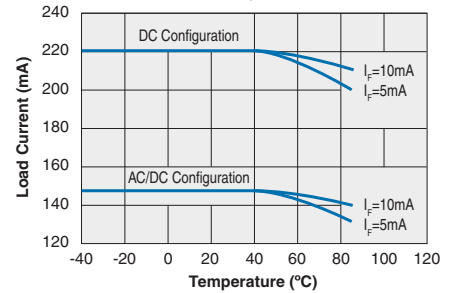
Typical Load Current vs. Load Voltage AC/DC Configuration
($I_F=5mA, T_A=25°C$)



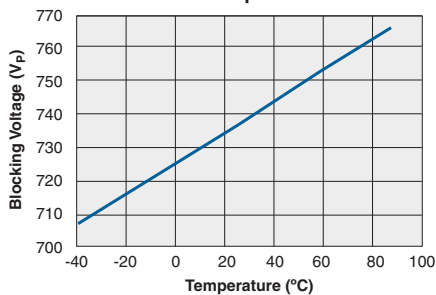
Typical Load Current vs. Load Voltage DC-Only Configuration
($I_F=5mA, T_A=25°C$)



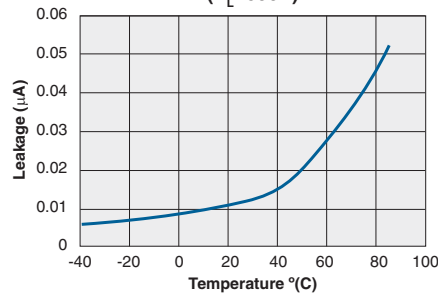
Maximum Load Current vs. Temperature



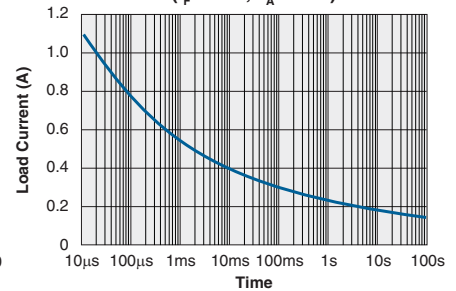
Typical Blocking Voltage vs. Temperature



Typical Leakage vs. Temperature Measured across Pins 4&6
($V_L=600V$)



Energy Rating Curve
($I_F=5mA, T_A=25°C$)



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PLA192 / PLA192S	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PLA192 / PLA192S	250°C for 30 seconds

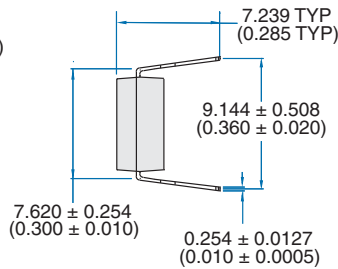
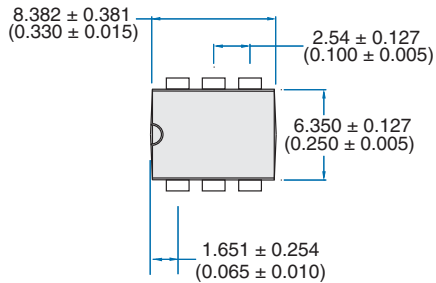
Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

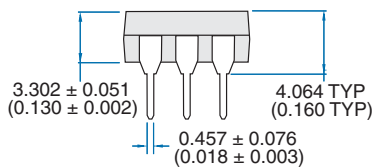
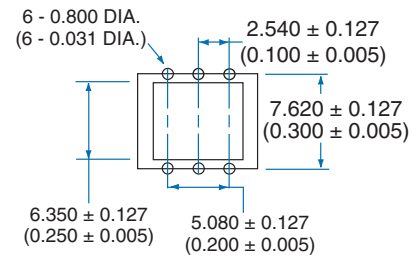


MECHANICAL DIMENSIONS

PLA192

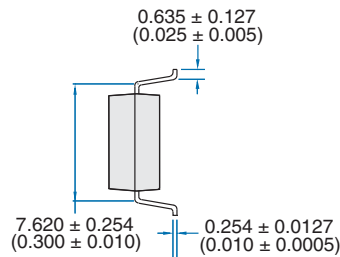
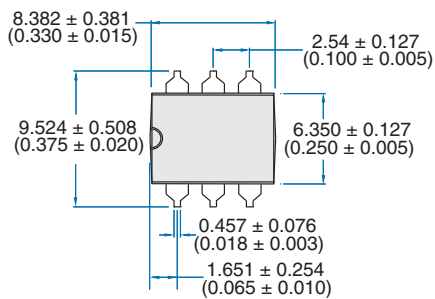


PCB Hole Pattern

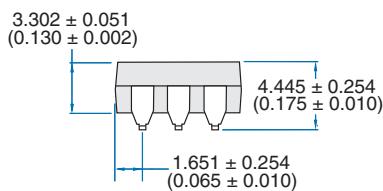
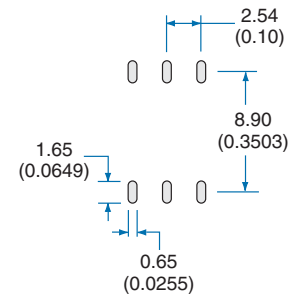


Dimensions
mm
(inches)

PLA192S

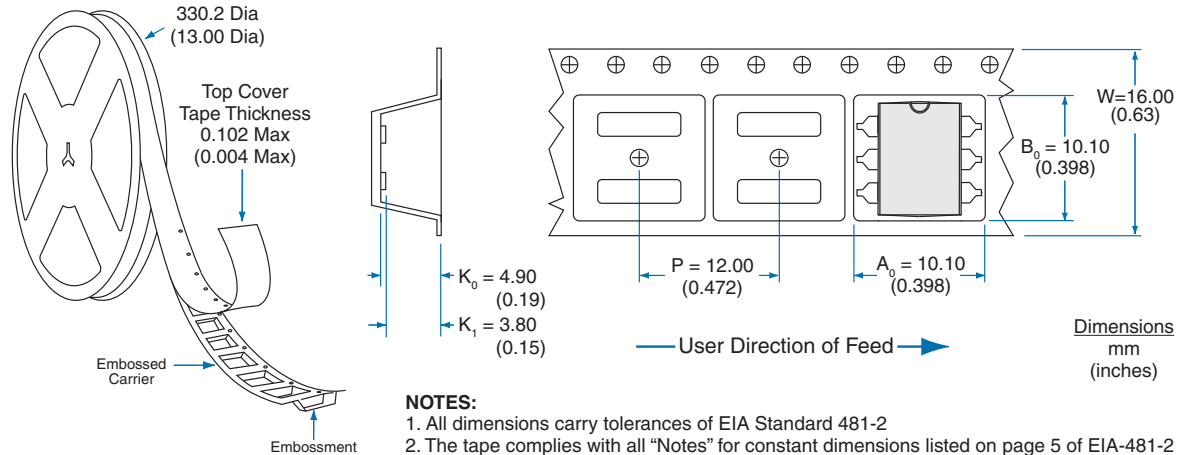


PCB Land Pattern



Dimensions
mm
(inches)

PLA192S Tape & Reel



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